

Electronic Patent Application Fee Transmittal

Application Number:	10595920
Filing Date:	19-May-2006
Title of Invention:	Photosensitive resin composition, photosensitive element, resist pattern forming method and process for manufacturing printed circuit board

First Named Inventor/Applicant Name:	Ken Sawabe
Filer:	Joerg-Uwe V. Szipl/Nichole Vasquez
Attorney Docket Number:	SOEI0021

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Claims in excess of 20	1615	2	50	100
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Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				910